



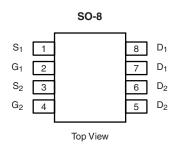
# **Dual P-Channel 30-V (D-S) MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)		
- 30	0.053 at V <sub>GS</sub> = - 10 V	- 4.9		
	0.090 at V <sub>GS</sub> = - 4.5 V	- 3.7		

#### **FEATURES**

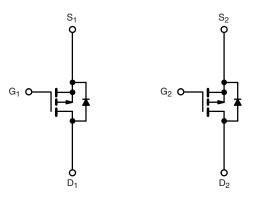
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFETs
- Compliant to RoHS Directive 2002/95/EC





Ordering Information: Si4953ADY-T1-E3 (Lead (Pb)-free)

Si4953ADY-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b>	$\Gamma_A = 25  ^{\circ}\text{C}$ , unle	ss otherwise r	noted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V <sub>DS</sub>	- 30		\/
Gate-Source Voltage		V <sub>GS</sub>	± 20		V
Continuous Dunin Courset /T 150 °C\A	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	- 4.9	- 3.7	•
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 70 °C		- 3.9	- 2.9	
Pulsed Drain Current		I <sub>DM</sub>	- 30		Α
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	- 1.7	- 0.9	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C	D.	2.0	1.1	W
	T <sub>A</sub> = 70 °C	- P <sub>D</sub>	1.3	0.7	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Marrian Incation to Anchion to	t ≤ 10 s	- R <sub>thJA</sub>	52	62.5	
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		90	110	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	32	40	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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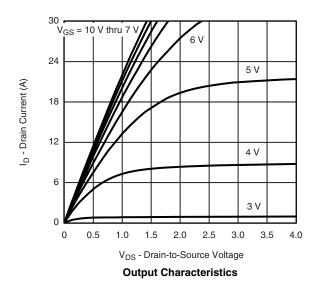
<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted								
Parameter	Symbol	Test Conditions Min.		Тур.	Max.	Unit		
Static								
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$	- 1			V		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA		
Zero Gate Voltage Drain Current	I	V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V			- 1	μА		
	IDSS	V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 25			
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = - 5 V, V <sub>GS</sub> = - 10 V	- 30			Α		
	D	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 4.9 A		0.045	0.053	0		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -3.7 \text{ A}$		0.075	0.090	Ω		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 4.9 A		9		S		
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	I <sub>S</sub> = - 1.7 A, V <sub>GS</sub> = 0 V		- 0.8	- 1.2	V		
Dynamic <sup>b</sup>								
Total Gate Charge	$Q_g$			15	25			
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -4.9 \text{ A}$		4		nC		
Gate-Drain Charge	Q <sub>gd</sub>			2				
Turn-On Delay Time	t <sub>d(on)</sub>			7	15			
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 15 $\Omega$		10	20			
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ - 1 A, $V_{GEN}=$ - 10 V, $R_g=6~\Omega$		40	80	ns		
Fall Time	t <sub>f</sub>			20	40			
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	$I_F = -1.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$		30	60			

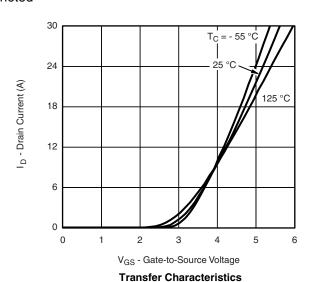
#### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

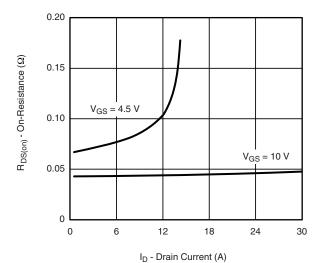
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



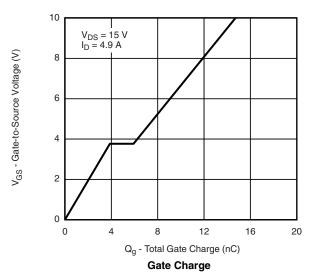


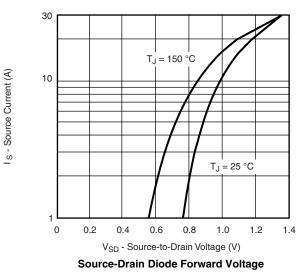


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On-Resistance vs. Drain Current

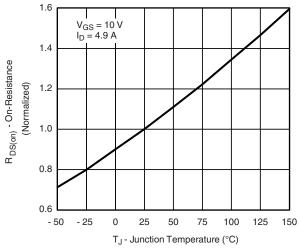




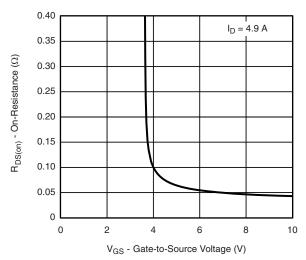
1500
1200
Ciss
900
Coss
300
Crss
0 600
0 6 12 18 24 30

V<sub>DS</sub> - Drain-to-Source Voltage (V)





On-Resistance vs. Junction Temperature

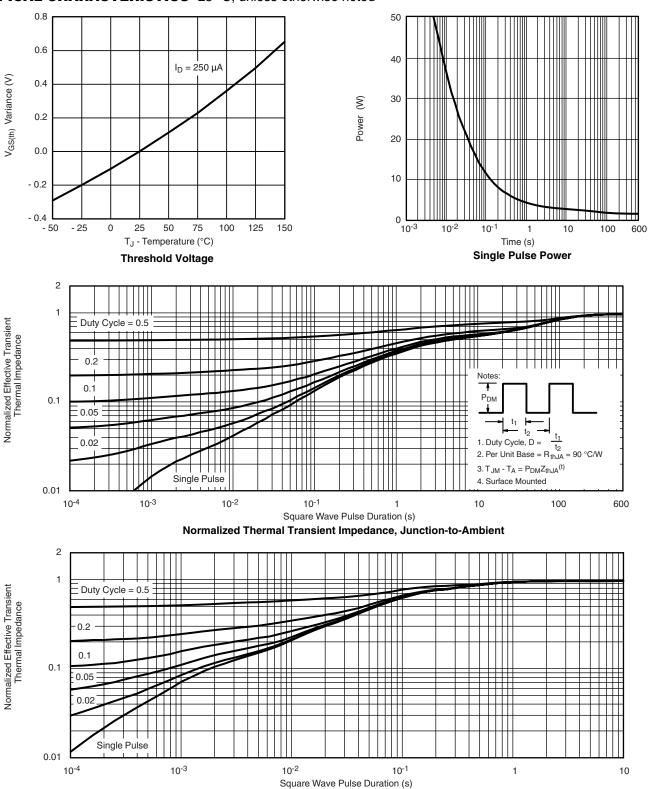


On-Resistance vs. Gate-to-Source Voltage

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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppq?71091">www.vishay.com/ppq?71091</a>.

Normalized Thermal Transient Impedance, Junction-to-Foot



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